

# KTS1605

## 5A Slew Rate Controlled Load Switch with Reverse Blocking

#### **Features**

- Operating Range: 1.5V~5.5V
- Low Rds(ON) MOSFET: Typ. 13.4mΩ @ 3.3V
- Continuous DC current up to 5A
- Built-in slew rate controlled turn-on: 2.7ms
- Low quiescent current < 1µA
- ESD Protection
  - ► Human Body Model : 8kV
  - ► Charged Device Model : 2.0kV
  - ► Compliance to IEC61000-4-2 Level 4
    - Contact Discharge : 8kV
    - Air Discharge : 15kV
- Output Auto Discharge when Disabled option (-1)
- Pb-Free Packages:
  - ▶ WLCSP-6, 1.0 x 1.5mm
  - ► RoHS and Green Compliant
- -40°C to +85°C Temperature Range

#### **Applications**

- Mobile Phones & Tablets
- SSD (Solid State Drive)
- Portable Instruments
- DSC, DVR, GPS

# Brief Description

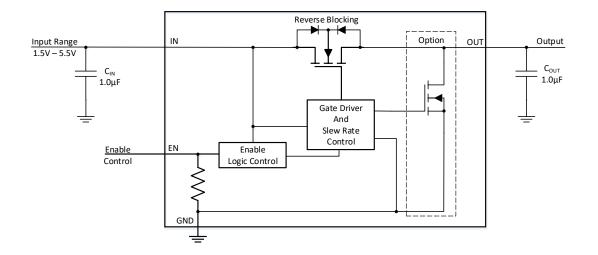
The KTS1605 is slew rate controlled load switch designed for 1.5V to 5.5V operation. It features a controlled soft-on slew rate of typical 2.7ms that limits the inrush current for designs with heavy capacitive loads and thereby minimizing any resulting voltage droop at the power rails.

The very low RDS(ON) allows currents up to 5A, whilst minimizing the power dissipation and voltage drop from supply to load. The KTS1605 features an active high enable pin, which is capable of interfacing directly with low input control signals, without any additional level shifting circuitry. The KTS1605 also includes an active pull-down to ensure the device remains off, should the enable be allowed to float.

The KTS1605 provides reverse blocking in the OFF state to ensure that power supplies are not discharged.

In addition, the KTS1605 has an option for output auto discharge feature. This enables the device to quickly discharge the output when the device is disabled.

The KTS1605 is available in an optimized, lead-free, fully green compliant, small 6-pin WLCSP 1.0 x 1.5mm package with 0.5mm pitch



## **Typical Application**

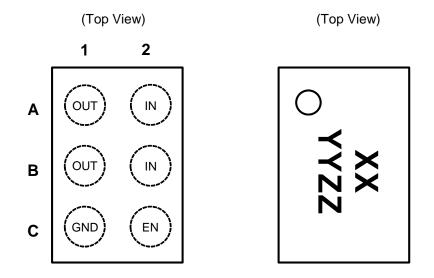


# **KTS1605**

## **Pin Descriptions**

Pin #	Name	Function
A1, B1	OUT	Power-switch output. Connect a 1.0uF ceramic capacitor from OUT to GND as close as possible to the IC is recommended. (-1) Option includes an output discharge transistor.
A2, B2	IN	Power-switch input voltage. Connect a $1.0\mu F$ or greater ceramic capacitor from IN to GND as close as possible to the IC.
C1	GND	Ground connection
C2	EN	Enable input, logic high turns on power switch.

WLCSP-6, 1.0 x 1.5 x 0.620 mm



 $\begin{array}{l} \mbox{6-Bump 1.0mm x 1.5mm x 0.620mm micro SMD Package} \\ \mbox{Top Mark} \\ \mbox{XX = Device Code} \\ \mbox{YY = Date Code, ZZ = Assembly Code} \end{array}$ 



## Absolute Maximum Ratings<sup>1</sup>

#### (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Description	Value	Units	
IN, OUT, EN	Input voltage, Enable Input Voltage, Output Voltage to GND	-0.3 to +6.0	V	
ISW	Maximum Continuous Switch Current (IMAX)	5.0	Α	
ESD IEC	ESD Withstand Voltage (IEC 61000-4-2) <sup>2</sup> (IN and OUT when bypassed with 1.0µF capacitor minimum)	Air: 15 Contact: 8	kV	
ESD HBM	Human Body Model (HBM) ESD Rating <sup>3,4</sup>	8	kV	
ESD CDM	Charge Device Model (CDM) Rating <sup>3,4</sup>	2.0		
ESD MM	Machine Model (MM) ESD Rating	400	V	
TJ	Operating Junction Temperature Range	-40 to 125		
Ts	Storage Temperature Range	-65 to 150	°C	
TLEAD	Maximum Soldering Temperature (at leads, 10sec)	300		
MSL	Moisture Sensitivity <sup>5</sup>	Level 1		

#### **Thermal Capabilities**<sup>6</sup>

Symbol	Description	Value	Units	
θ <sub>JA</sub>	Thermal Resistance – Junction to Ambient	85	°C/W	
PD	Maximum Power Dissipation at $T_A \le 25^{\circ}C$	1.17	W	
ΔP <sub>D</sub> /°C	Derating Factor Above $T_A = 25^{\circ}C$	1.17	mW/°C	

## **Ordering Information**

Part Number	Marking <sup>7</sup>	<b>Operating Temperature</b>	Auto-Discharge	Package
KTS1605EUB-TR	JCYYZZ	-40°C to +85°C	NO	WLCSP-6
KTS1605EUB-1-TR	JLYYZZ	-40 C 10 +65 C	YES	1.0 x 1.5 x 0.620mm

<sup>1.</sup> Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation at conditions other than the operating conditions specified is not implied. Only one Absolute Maximum rating should be applied at any one time.

<sup>2.</sup> Guaranteed by design and not 100% tested

<sup>3.</sup> According to JEDEC standard JESD22-A108

<sup>4.</sup> This device series contains ESD protection and passes the following tests: Human Body Model (HBM) ±2.0 kV per JEDEC standard: JESD22–A114 for all pins. Machine Model (MM) ±200 V per JEDEC standard: JESD22–A115 for all pins.

<sup>5.</sup> Moisture Sensitivity Level (MSL): 1 per IPC/JEDEC standard: J-STD-020.

<sup>6.</sup> Junction to Ambient thermal resistance is highly dependent on PCB layout. Values are based on thermal properties of the device when soldered to a PCB board.

<sup>7. &</sup>quot;JC/JL" is the device Code, "YYZZ" the date and assembly code.



## **Electical Characteristics**<sup>8</sup>

Symbol	Description	Conditions	Min	Тур	Max	Units
Vin	Input Voltage Range		1.5		5.5	V
la	Quiescent Current	$V_{IN} = 1.5V$ to 5.5V, EN = Active, $I_{OUT} = 0mA$		8	14	μA
$I_{Q_OFF}$	No Load Quiescent Current	$V_{IN} = 1.5V$ to 5.5V, EN = Inactive, OUT = OPEN			1.0	μΑ
ISD	Shutdown Current	$V_{IN} = 1.5V$ to 5.5V, EN = GND, OUT = GND, $T_A = -40^{\circ}C$ to +85°C		2.0	4.0	μA
Ien leak	EN Input Leakage Current	$V_{EN} = 5.5 V, V_{IN} = 0 V$	-10		10	μA
IEN_LEAK	En input Leakage Ourient	$V_{EN}=0V,\ V_{IN}=5.5V$	-1.0		1.0	
		$V_{IN} = 5.5V, I_{OUT} = 1A, T_A = 25^{\circ}C$		10.2	15.0	mΩ
		$V_{IN} = 5.0V, I_{OUT} = 1A^9$		10.5		
		$V_{IN} = 4.5V, I_{OUT} = 1A, T_A = 25^{\circ}C$		11.1	16.0	
Rds(on)	On-Resistance	$V_{IN} = 3.3V, I_{OUT} = 500mA, T_A = 25^{\circ}C$		13.4	18.0	
		$V_{IN} = 2.5V, I_{OUT} = 500 \text{mA}^9$		16.6		
		V <sub>IN</sub> = 1.8V, I <sub>OUT</sub> = 500mA <sup>9</sup>		23.0		
		V <sub>IN</sub> = 1.5V, I <sub>OUT</sub> = 500mA, T <sub>A</sub> = 25°C		29.4	40.0	
VIH	EN Input Logic High Level	V <sub>IN</sub> = 1.5V to 5.5V	1.15			
		V <sub>IN</sub> = 1.8V to 5.5V			0.65	V
VIL	EN Input Logic Low Level	V <sub>IN</sub> = 1.5V to 1.8V			0.60	
ROUT_PD	OUT Pull-Down (Option -1)	$V_{EN} = 0V^9$ , $I_{PD} = 2mA$		30		Ω
Ren_down	EN Pull-down Resistor	$V_{IN} = V_{EN} = 1.5V$ to $5.5V$	6.38	7.65	8.86	MΩ
lout_out	VOUT Shutdown Current	$V_{EN} = 0V, V_{OUT} = 4.2V,$ $V_{IN} = $ Short to GND			1.0	μA
tDELAY_ON	Turn-On Delay Time <sup>10</sup>			1.7		
t <sub>R</sub>	V <sub>OUT</sub> Rise Time <sup>10</sup>	$V_{IN} = 4.5V, R_{LOAD} = 5\Omega,$ $C_{LOAD} = 100\mu F, T_A = 25^{\circ}C$		2.7		ms
ton	Turn-On Time <sup>11</sup>	On Time <sup>11</sup> Οιομι, τα = 25 Ο		4.4		
tdelay_on	Turn-On Delay Time <sup>10</sup>			1.7		
t <sub>R</sub>	VOUT Rise Time <sup>10</sup> VIN = 4.5V, RLOAD = $150\Omega$ , CLOAD = $100\mu$ F, Ta = $25^{\circ}$ C			1.5		ms
ton	Turn-On Time <sup>11</sup>	$CLOAD = 100\mu$ , $TA = 25$ C		3.2		
tDELAY_OFF	Turn-Off Delay Time <sup>10</sup>			1.8		ms
t⊨	V <sub>OUT</sub> Fall Time <sup>10</sup>	$V = 4.5V, R_{LOAD} = 150\Omega,$ $C_{LOAD} = 100\mu F, T_A = 25^{\circ}C$		34		
toff	Turn-Off Time <sup>12</sup>	- CLOAD = 100µr, 1A = 25 C		35		
tdelay_off	Turn-Off Delay Time <sup>10</sup>	$V = 4.5V, R_{LOAD} = 150\Omega,$		0.8		ms
t⊧	Vout Fall Time <sup>10</sup>	$C_{LOAD} = 100\mu$ F, $T_A = 25^{\circ}$ C		9.0		
toff	Turn-Off Time <sup>12</sup> KTS1605-1 Only			9.8		1

The *Min* and *Max* specs are applied over the full operation temperature range of -40°C to +85°C,  $V_{IN} = 1.5V$  to 5.5V unless otherwise noted, while *Typ* values are specified at  $V_{IN} = 4.5V$  and room temperature ( $T_A = 25^{\circ}C$ ) unless otherwise noted.

11.  $t_{ON} = t_R + t_{DELAY_ON}$ 

12.  $t_{OFF} = t_F + t_{DELAY_OFF}$ 

<sup>8.</sup> All specifications are 100% production tested at  $T_A = +25^{\circ}$ C, unless otherwise noted. Specifications are over -40°C to +85°C and are guaranteed by design

<sup>9.</sup> Guaranteed by design and not 100% tested

<sup>10.</sup>  $t_{DELAY\_ON}/t_{DELAY\_OFF}/t_R/t_F$  are defined in Figure 1



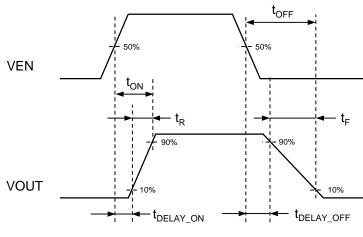
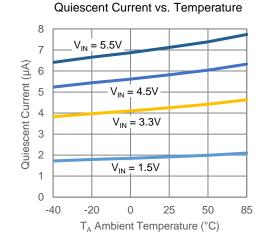


Figure 1. Timing Diagram

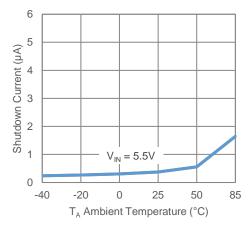


### **Typical Characteristics**

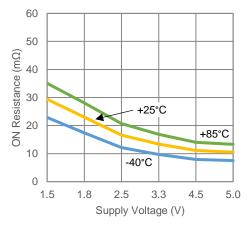


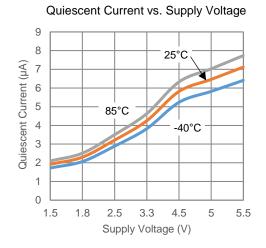
 $V_{IN} = 5V$ ,  $C_{IN} = 0.1\mu$ F,  $C_{OUT} = 1\mu$ F, Temp = 25°C unless otherwise specified.

Shutdown Current vs. Temperature

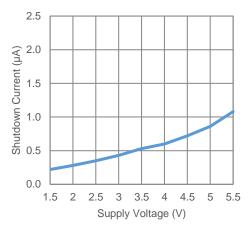


ON Resistance vs. Supply Voltage ( $I_{OUT} = 500$ mA)

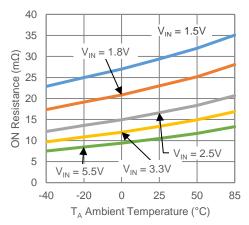




Shutdown Current vs. Supply Voltage



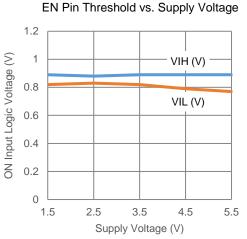
ON Resistance vs. Temperature (I<sub>OUT</sub> = 500mA)





## **Typical Characteristics (continued)**

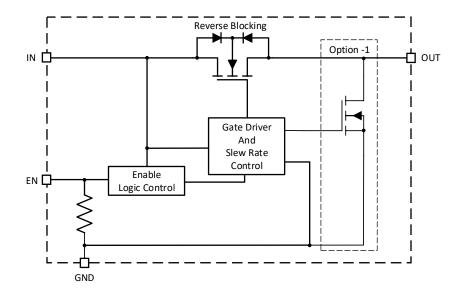
 $V_{IN} = 5V$ ,  $C_{IN} = 0.1\mu$ F,  $C_{OUT} = 1\mu$ F, Temp = 25°C unless otherwise specified.



Turn-On & Turn-Off Response In-rush Current Waveform  $(V_{IN} = 4.5V, C_{IN} = 10\mu F, C_{OUT} = 100\mu F, R_{L} = 5\Omega)$  $(V_{IN} = 5.0V, C_{IN} = 10 \mu F, C_{OUT} = 100 \mu F, R_L = OPEN)$ Tek Run Trig'd Tek Stop V<sub>IN</sub> 2V / div V<sub>оит</sub> 2V / div Vout 2V / div 1 I<sub>IN</sub> 100mA / div I<sub>IN</sub> 500mA / div 2 2 V<sub>EN</sub> 2V / div V<sub>EN</sub> 2V / div 2ms / div 2ms / div



## **Functional Block Diagram**



## **Functional Description**

The KTS1605 is an advanced slew-rate controlled high-side load switch comprised of a low resistance MOSFET power switch, level shift with slew-rate control logic and reverse blocking protection. The KTS1605 is a low resistance MOSFET power distribution switch designed to connect an external voltage, such as a DC power supply or battery, directly to the system. The high-side MOSFET is turned-on sequence is initiated via an active high, low voltage logic voltage signal. Once above the input threshold voltage, the MOSFET turn-on is slew-rate limited to avoid excessive current surges, due to high capacitance loads. By limiting the turn-on, large voltage over-shoot can also be avoided. Once fully on the MOSFET will provide a low resistance path to the load, both minimizing the voltage drop from IN to OUT, while keeping the power dissipation to a minimum.

Should the voltage on the output of The KTS1605 switch, in the OFF state, be higher than the input voltage, Reverse Blocking circuitry will be activated to stem the flow of current preventing power supplies for discharging.

In addition, the KTS1605 has an option for output auto discharge feature. This enables the device to quickly discharge the output when the device is disabled.

The KTS1605 integrates a pull-down resistor on the enable pin to ensure that the device should remain OFF when the EN is left floating.





### **Application Information**

#### Enable Input

The EN pin is compatible with active HIGH GPIO and CMOS logic voltage levels and operates over the 1.5V to 5.5V operating voltage range. The KTS1605 incorporates an internal pull-down resistor on the enable pin, to ensure that the device remains OFF, in the event that the pin is left floating.

#### **Reverse Current Blocking**

The KTS1605 implements reverse current blocking circuitry, to prevent reverse current flow through the switch. The reverse current blocking circuitry is active when the device is in the OFF state.

#### Auto Discharge Option

The KTS1605 has an option for auto discharging the output when the part is disabled. This enables the device to quickly discharge the output when the device is disabled, and to remove any residual capacitor voltage.

#### **Input Capacitor**

To limit the voltage drop on the input supply caused by transient inrush currents, an input bypass capacitor is recommended. A minimum capacitance of  $1.0\mu$ F, must be placed as close as possible between pins VIN and GND) to be Compliant with IEC 61000-4-2 (Level 4).

Higher value capacitors can further help to reduce the voltage drop. Ceramic capacitors are recommended for their ability to withstand input current surges from low impedance sources such as batteries in portable devices.

#### **Output Capacitor**

Depending on the sink current during system start-up and system turn-off, a capacitor must be placed on the output. A  $1.0\mu$ F or larger capacitor across OUT and GND pins is recommended to accommodate load transient condition. This capacitor can also help to prevent parasitic inductance which can force the output voltage to fall below GND during turn-off. The output capacitor has minimal effect on The KTS1605's turn-on slew-rate time.

#### **Inrush Current**

Inrush current occurs when the device is turned on. Inrush current is dependent on output capacitance and slewrate control capability, as expressed by:

$$I_{INRUSH} = C_{OUT} \times \frac{V_{IN} - V_{INITIAL}}{t_R} + I_{OAD}$$

Where:

 $\begin{array}{l} C_{\text{OUT}} \text{ - Output capacitance} \\ t_{\text{R}} \text{ - Slew-rate or rise time at } V_{\text{OUT}} \\ V_{\text{IN}} \text{ - Input voltage} \\ V_{\text{INITIAL}} \text{ - Initial voltage at } C_{\text{OUT}} \text{, usually GND} \\ I_{\text{LOAD}} \text{ - Load current} \end{array}$ 

The KTS1605 has a 2.7ms of slew-rate capability under  $4.5V_{IN}$  at 1000uF of  $C_{OUT}$  and  $5\Omega$  of  $R_{LOAD}$  so inrush current can be minimized and no input voltage drop appears.



#### **Layout Guidelines**

The KTS1605 integrates a 5A rated MOSFET, and the PCB design rules must be respected to properly transfer the heat out of the silicon. By increasing PCB area, the  $R\theta_{JA}$  of the package can be decreased, allowing higher power dissipation.

For the best performance, all traces should be as short as possible to minimize the inductance and parasitic effects. The input and output capacitors should be kept as close as possible to the input and output pins respectively. Using wide traces for input, output, and GND help reducing the case to ambient thermal impedance.

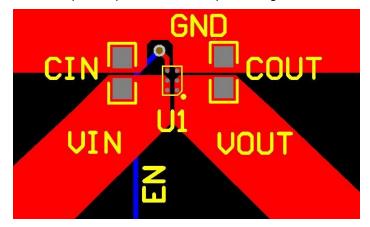


Figure 2. Recommended Layout for WLCSP-6 Package

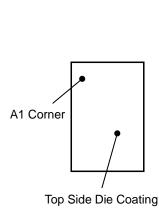


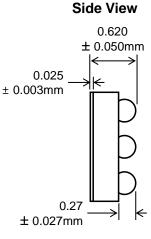
KTS1605

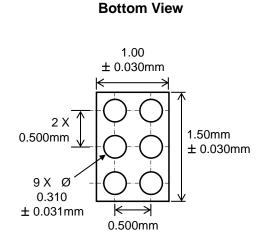
## **Packaging Information**

**Top View** 

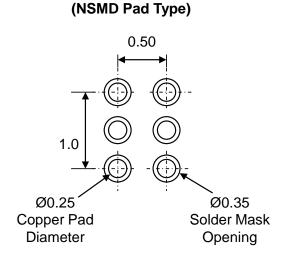
#### WLCSP-6, 1.0mm x 1.5mm x 0.620mm Package







#### **Recommended Footprint**



\* Dimensions are in millimeters.

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